

High IP3

Frequency Mixer

Level 17 (LO Power +17 dBm) 320 to 550 MHz

HJK-551H+



CASE STYLE: TTT881

Maximum Ratings

| | |
|---|----------------|
| Operating Temperature | -40°C to 85°C |
| Storage Temperature | -55°C to 100°C |
| LO Power | +19 dBm |
| RF Power | +20 dBm |
| Permanent damage may occur if any of these limits are exceeded. | |

Pin Connections

| | |
|--------|-------|
| LO | 2 |
| RF | 1 |
| IF | 3 |
| GROUND | 4,5,6 |

Features

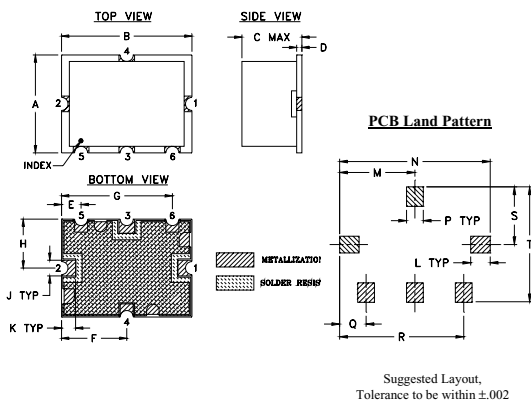
- high IP3, 30 dBm typ.
- excellent L-R isolation, 53 dB typ.;
- L-I isolation, 38 dB typ.

Applications

- base stations
- communication systems
- wireless application in Health care
- weather instruments/radar/satellites
- general aviation air to ground telephone
- land mobile radio
- aeronautical
- emergency

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Outline Drawing

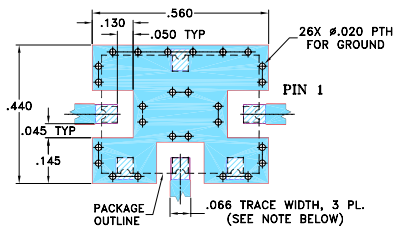


Suggested Layout,
Tolerance to be within ±.002

Outline Dimensions (inch)

| A | B | C | D | E | F | G | H | J | K |
|------|-------|-------|------|------|-------|-------|-------|------|-------|
| .38 | .50 | .23 | .020 | .075 | .250 | .425 | .187 | .050 | .050 |
| 9.65 | 12.70 | 5.84 | 0.51 | 1.91 | 6.35 | 10.80 | 4.75 | 1.27 | 1.27 |
| L | M | N | P | Q | R | S | T | wt. | |
| .070 | .270 | .540 | .060 | .095 | .445 | .208 | .415 | | grams |
| 1.78 | 6.86 | 13.72 | 1.52 | 2.41 | 11.30 | 5.28 | 10.54 | | 0.8 |

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



- NOTE:**
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
 3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

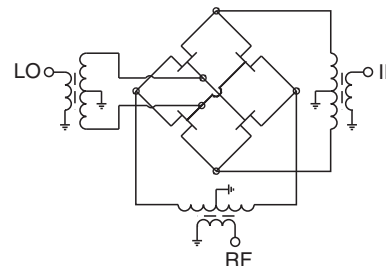
Electrical Specifications at 25°C

| Parameter | Condition | Min. | Typ. | Max. | Units |
|--------------------------|-----------|------|------|------|-------|
| Frequency Range, RF | | 320 | | 550 | MHz |
| Frequency Range, LO | | 275 | | 505 | |
| Frequency Range, IF | | 10 | | 150 | |
| Conversion Loss | | — | 7.0 | 8.3 | dB |
| LO to RF Isolation | | 43 | 53 | — | dB |
| LO to IF Isolation | | 30 | 38 | — | dB |
| IP3 | | — | 30 | — | dBm |
| 1 dB Compression (Input) | | | +20 | | dBm |

Typical Performance Data

| Frequency | | Conversion Loss (dB) | Isolation L-R | Isolation L-I | VSWR RF Port | VSWR LO Port | IP3 (dBm) |
|-----------|--------|----------------------|---------------|---------------|--------------|--------------|-----------|
| RF MHz | LO MHz | LO +17dBm | LO +17dBm | LO +17dBm | LO +17dBm | LO +17dBm | LO +17dBm |
| 316 | 271 | 6.84 | 57.84 | 42.84 | 1.99 | 3.00 | 32.72 |
| 340 | 295 | 6.73 | 56.55 | 41.08 | 1.94 | 2.71 | 32.75 |
| 380 | 335 | 6.75 | 55.62 | 38.82 | 1.86 | 2.06 | 34.75 |
| 404 | 359 | 6.65 | 55.97 | 37.93 | 1.85 | 1.66 | 37.26 |
| 412 | 367 | 6.68 | 56.16 | 37.86 | 1.82 | 1.54 | 35.33 |
| 420 | 375 | 6.57 | 56.22 | 37.86 | 1.80 | 1.45 | 37.63 |
| 460 | 415 | 6.63 | 56.44 | 38.55 | 1.74 | 1.43 | 36.38 |
| 492 | 447 | 6.76 | 58.22 | 39.37 | 1.78 | 1.71 | 34.45 |
| 500 | 455 | 6.79 | 58.62 | 39.51 | 1.79 | 1.78 | 37.29 |
| 508 | 463 | 6.79 | 58.51 | 39.94 | 1.81 | 1.85 | 36.32 |
| 516 | 471 | 6.81 | 58.62 | 40.05 | 1.83 | 1.91 | 35.57 |
| 524 | 479 | 6.84 | 59.47 | 40.29 | 1.86 | 1.97 | 33.94 |
| 532 | 487 | 6.87 | 60.05 | 40.92 | 1.87 | 2.03 | 34.83 |
| 540 | 495 | 6.91 | 60.08 | 41.21 | 1.91 | 2.08 | 34.18 |
| 548 | 503 | 6.98 | 59.66 | 41.58 | 1.95 | 2.12 | 34.86 |
| 556 | 511 | 7.05 | 57.21 | 42.05 | 1.99 | 2.17 | 31.13 |

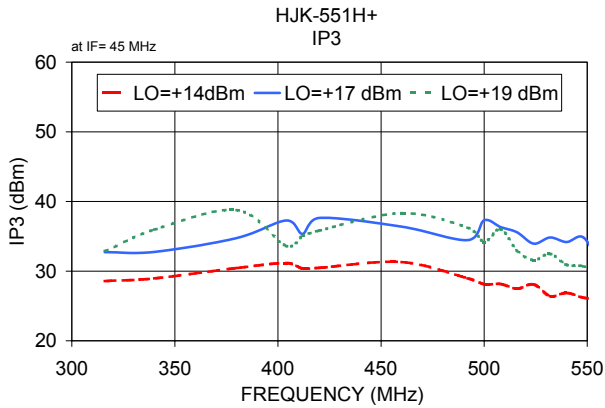
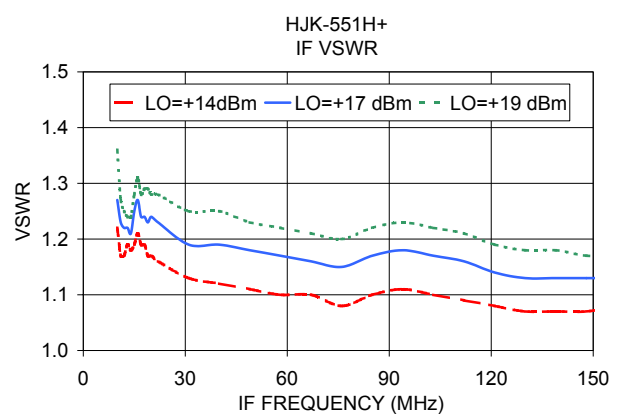
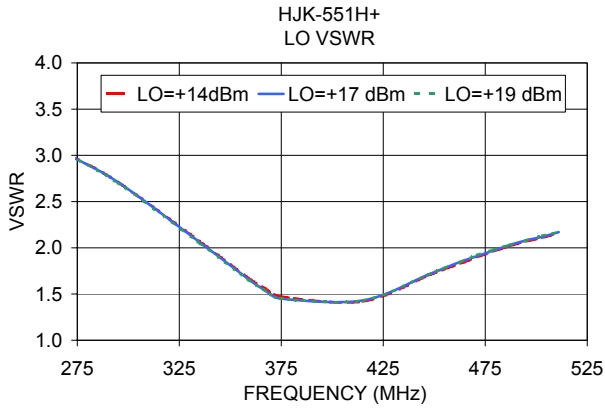
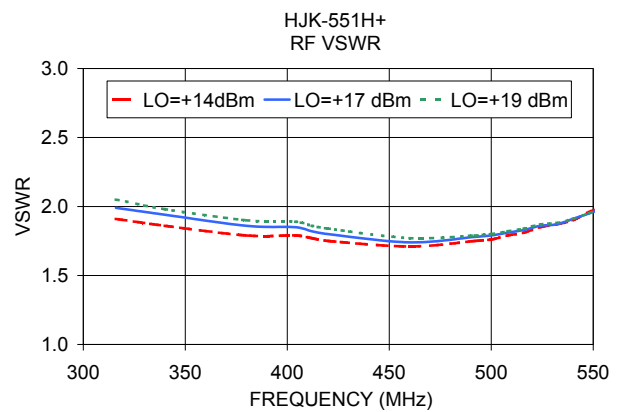
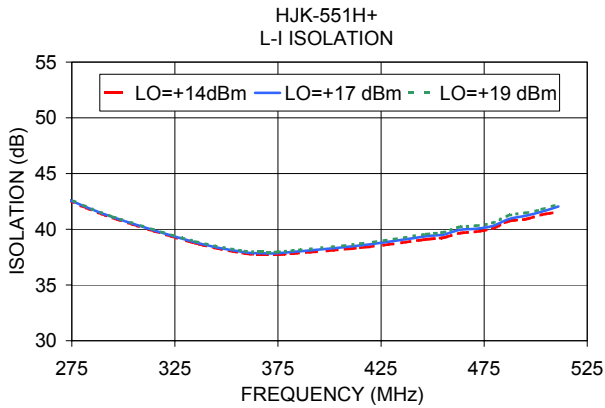
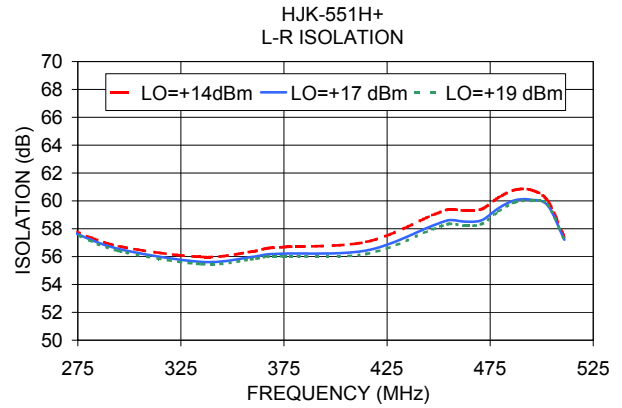
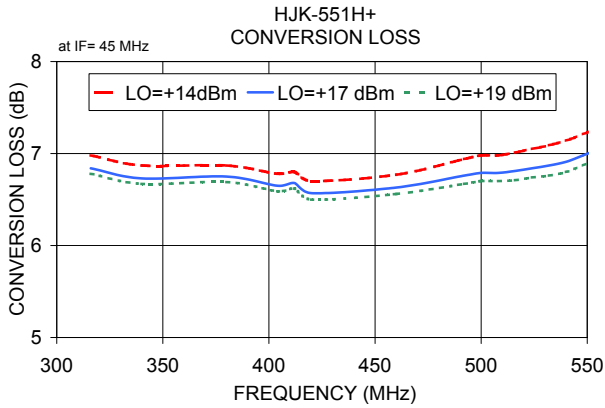
Electrical Schematic



Notes

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